Submissions to the 13th IEEE Integrated STEM Education Conference (ISEC '23), to be held on March 11, 2023, are open and accepted until January 22, 2023. ISEC is known for featuring cutting-edge research and experiences with integrated approaches to the study of science, math, and technology through experiences and activities based in engineering and other design disciplines. ISEC 2023 will be held at Applied Physics Laboratory, Johns Hopkins University, Maryland and will be alternating between Princeton University and Johns Hopkins University.

Please use this link to submit [https://edas.info/newPaper.php?c=30171](https://edas.info/newPaper.php?c=30171). You will need to set up an account in [EDAS](https://edas.info) before submitting if you do not already have one.

**Important Dates:**

- Full and Work-In-Progress Paper Deadline: January 23, 2023
- K-12 Poster Abstract Deadline: January 31, 2023
- Workshop Proposals Deadline: January 31, 2023
- Student Award Applications Deadline: February 20, 2023
- Exhibits Deadline: February 27, 2023
- Acceptance of Notification: February 17, 2023
- Final Submission Deadline: March 3, 2023

**Submission Information:**

Submissions are accepted in the following three categories:

1. **Papers (Full and Work In Progress)**
2. **Posters** by K-12 students
3. **Workshops**

Your work must not have been published or submitted for publications elsewhere.

**Suggested Topics for Papers towards STEM (Science, Technology, Engineering, Mathematics):**

- Integration of Education and Interdisciplinary Education in STEM
- Development and Implementation of policies to support Integrated STEM
- Engineering Activities in STEM
- Pre-College Initiatives and Outreach Program
- Diversity and Inclusion in STEM/STEAM from P-12 to higher Education
- Fundamental and Applied Research in Integrated STEM

All submissions are submitted via EDAS.info. For full and work-in-progress papers, post the pdf or word document (no LaTeX) along with the author and abstract information. For posters and workshops, no separate document is needed; the information requested by EDAS, including the abstract, is sufficient. The paper submission could be one or both of the following:

- Work In Progress (WIP): 2 - 4 pages (Preliminary or Initial stage of Research/Investigation)
- Full Paper: 5 – 8 pages

There is no preliminary abstract phase for WIP or full papers. For page limits and conference submission template structure, please follow the template for Full and WIP papers posted in the conference website
Papers that do not follow the template will be returned for reformatting.

**Posters** by K-12 students may feature student STEM/STEaM research or experiences. Submit an abstract describing the content of your poster (max 500 words) for review to EDAS. Please follow the template for K-12 Poster posted in the conference website ([https://ewh.ieee.org/conf/stem/author.html](https://ewh.ieee.org/conf/stem/author.html)).

**Workshop** proposals should provide the title, topic, focus, proposed activities, and a short statement of presenter expertise in an abstract of no more than 750 words. There are no papers associated with a workshop. Workshops are typically scheduled for 90 minutes.

All accepted submissions will be scheduled for presentation at the conference and included in the conference proceedings. Accepted papers will be submitted for inclusion into IEEE Xplore. Workshop documents will not be submitted to Xplore.

**Exhibits:** Potential Exhibitors are requested to send mail to ieee.isec@gmail.com if interested in participating as an exhibitor. ISEC supported exhibits every year and virtual exhibits would also be explored for the event in 2023.

ISEC 2023 is sponsored by the IEEE Princeton/Central Jersey Section with technical co-sponsorship by IEEE Baltimore Section, IEEE Regions 1 and 2, and the IEEE Education Society.

Please visit [http://ewh.ieee.org/conf/stem](http://ewh.ieee.org/conf/stem) for more information and the fee schedule. Contact us at ieee.isec@gmail.com for more information.

**We look forward to your participation in ISEC 2023!**